

## **IRVINE SENSORS CORPORATION NEWS RELEASE**

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### **FOR IMMEDIATE RELEASE**

#### **IRVINE SENSORS TO PRESENT AT ROTH CAPITAL NEW YORK CONFERENCE Presentation scheduled for Wednesday, September 15, Noon Eastern Time**

COSTA MESA, CALIFORNIA – September 2, 2004 -- Irvine Sensors Corporation (Nasdaq: IRSN, Boston Stock Exchange: ISC) announced today that its Chief Financial Officer, John Stuart, is scheduled to present an overview of company status and plans at the Roth Capital Partners New York Investor Conference, taking place September 13-15 at the St. Regis Hotel in New York City. More than 200 public companies from technology, healthcare, financial services and consumer products sectors are expected to present at the Conference, which will be attended by securities analysts, fund managers and other institutional investors.

The 2004 Conference represents a more than two-fold growth over the 94 companies that were showcased in Roth's 2003 New York conference, attended by over 650 institutional investors. More information about the Roth Capital Partners New York Conference is available at:  
<http://www.rothcp.com/Conf%20NY%20Web%20Site/Roth.htm>.

The Irvine Sensors presentation is set for 12 Noon, September 15, Eastern Time. A live web cast of the presentation will be broadcast at the following link:

<http://www.wsw.com/webcast/roth4/irsn/>

This link will also access a replay of the web cast shortly after the presentation ends and will be available through October 1, 2004. The web cast link and replay will also be made available on the main page of Irvine Sensors' web site [www.irvine-sensors.com](http://www.irvine-sensors.com).

Irvine Sensors Corporation, headquartered in Costa Mesa, California, is primarily engaged in the design, manufacture and sale of stacked chip assemblies, infrared cameras and application-specific electronics. The Company also conducts funded research and development related to high density electronics, miniaturized sensors, optical interconnection technology, high speed routers, image processing and low-power analog and mixed-signal integrated circuits for diverse systems applications.